

Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAME	SYMBOL	LIMIT	UNITS		
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	<u>+</u> 12	V	
Continuous Drain Current	T _A =25°C	ID	8.0		
Pulsed Drain Current		I _{DM}	32	A	
Power Dissipation	T _A =25°C	_	2.0	W	
	Derate above 25°C	PD	16	mW/ °C	
Operating Junction and Storage	T _J ,T _{STG}	-55~150	°C		
Typical Thermal Resistance - Junction to Ambient ^(Note 4)	R _{θJA}	62.5	°C/W		



Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	V _{GS} =0V,I _D =250uA	30	-	-	- V 2.5
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} ,I _D =250uA	1.0	1.7	2.5	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V,I _D =8A	-	16	18	mΩ
		V _{GS} =4.5V,I _D =6A	-	23	28	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1.0	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} = <u>+</u> 12V,V _{DS} =0V	-	-	<u>+</u> 100	nA
Dynamic (Note 5)						
Total Gate Charge	Qg		-	4.3	-	nC
Gate-Source Charge	Q_gs	V _{DS} =15V, I _D =8A, V _{GS} =4.5V ^(Note 2,3)	-	1.3	-	
Gate-Drain Charge	Q_gd	V _{GS} -4.5V	-	1.6	-	
Input Capacitance	Ciss	V _{DS} =25V, V _{GS} =0V,	-	392	-	pF
Output Capacitance	Coss		-	76	-	
Reverse Transfer Capacitance	Crss	f=1.0MHZ	-	54	-	
Turn-On Delay Time	td _(on)	V _{DS} =15V, I _D =1A, V _{GS} =10V, R _G =6Ω	-	5.9	-	
Turn-On Rise Time	tr		-	11	-	ns
Turn-Off Delay Time	td _(off)	(Note 2,3)	-	17	-	
Turn-Off Fall Time	tf		-	3.8	-	
Drain-Source Diode						
Maximum Continuous Drain-Source	ls				1.5	A
Diode Forward Current	IS				1.5	
Diode Forward Voltage	V_{SD}	I _S =1.0A, V _{GS} =0V	-	0.73	1.0	V

NOTES :

- 1. Pulse width300us, Duty cycle2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. The maximum current rating is package limited.
- 4. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper
- 5. Guaranteed by design, not subject to production testing.



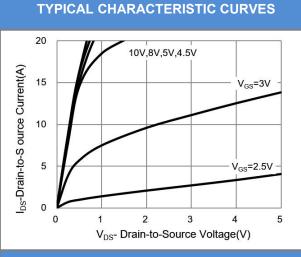


Fig.1 On-Region Characteristics

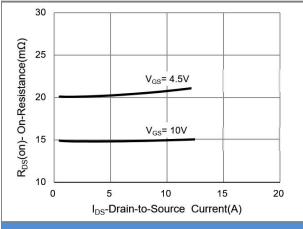
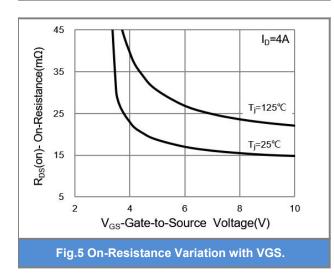


Fig.3 On-Resistance vs. Drain Current



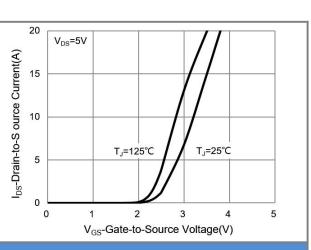


Fig.2 Transfer Characteristics

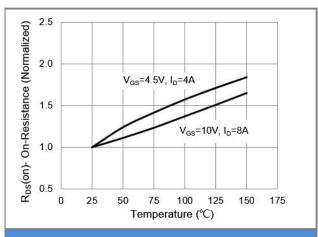
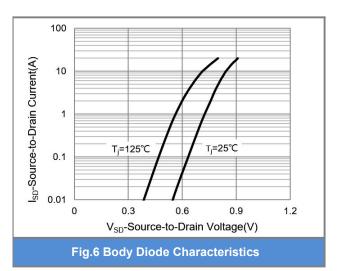
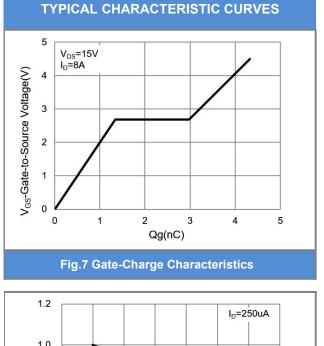


Fig.4 On-Resistance vs. Junction temperature







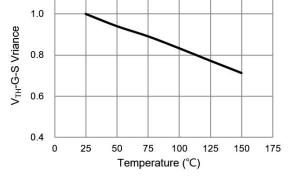
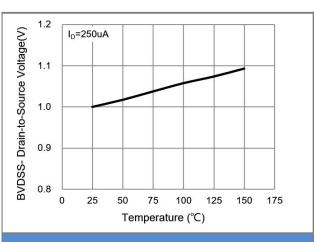


Fig.9 Threshold Voltage Variation with Temperature





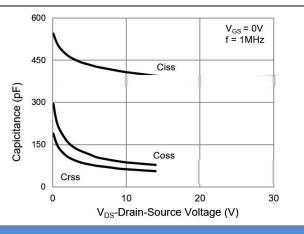


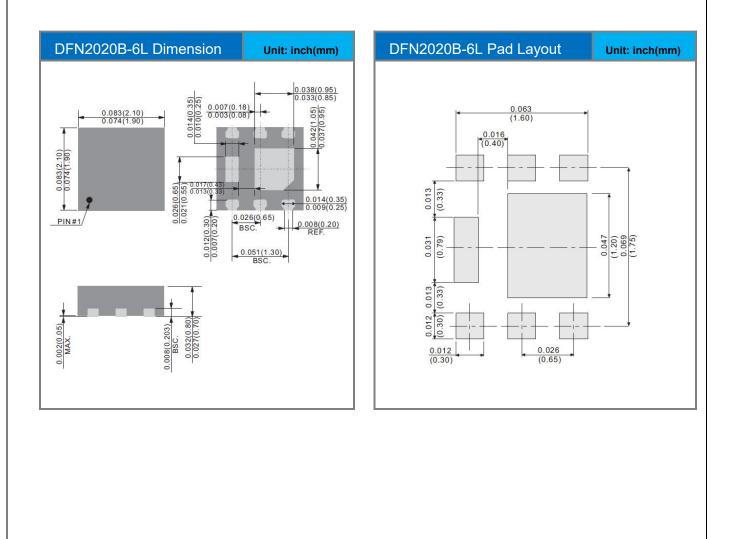
Fig.10 Capacitance vs. Drain-Source Voltage.



PART NO PACKING CODE VERSION

Part No Packing Code	Package Type	Packing Type		
CSM312N8D2-2	DFN2020B-6L	3K pcs / 7" reel		

MOUNTING PAD LAYOUT





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